

A high, performance, high-reliability 3U VPX RF processor based on the Xilinx Virtex-5QV FPGA with a high-speed ADC/DAC/PLL Mezzanine Card. Multiple build options to support orbital and interplanetary missions including Synthetic Aperture Radar, Communications, Signal Collection/Analysis, On-Board Processing and more. On-orbit since 2019.



Mission Ready Multi-Function RF and On-Board Processing

Re-programmable Multi-Function RF

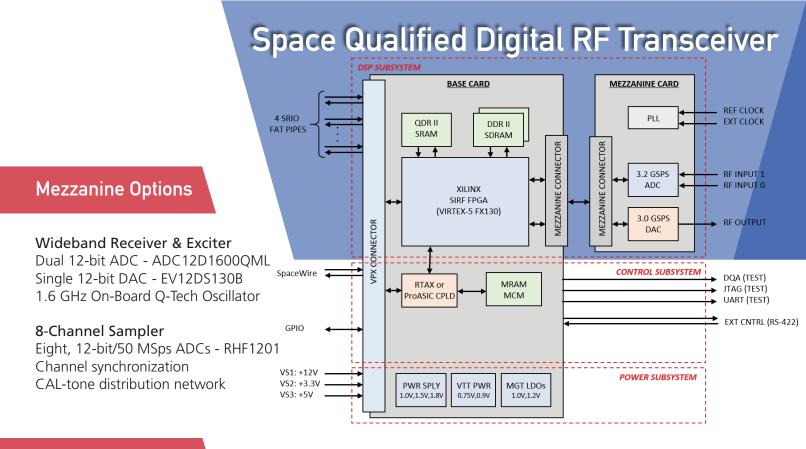
Trident's SQDRT is based on our powerful, flexible multifunction RF and processing architecture, providing programmability over all key RF/Processing features in a very small size, weight, and power footprint. A mission enabling design, the SQDRT can be incorporated at the module level or used as part of Trident's MFREU Products.

Mission Ready

TRL9 with multiple RF modalities, a mission-ready solution using radiation-hardened parts, redundancy, a robust mechanical design and multiple build options to provide a low C-SWaP, high performance module. Reference designs and custom FW development available as well as custom integration for a wide range of missions.







Specifications

SWaP 3U VPX, 1" pitch, < 800g (mezzanine dependent), <50 W (FPGA and Mezzanine)

-20 C to +50 C operating temperature range Accepts VITA-78 +12V, +3.3V, +5V Power Rails

FPGA Options Xilinx Virtex5 XQR5VFX130 or XQ5VFX130T depending on build option

Memory 16 MB QDR II+ SRAM Memory w/EDAC (2M x 72-bit)

1024 MB DDR II SDRAM memory w/EDAC (two independent 64M x 72-bit banks)

MRAM for FPGA Configuration and Load Storage

Mezzanine Site High-speed LVDS and GPIO interface

Coherent Exciter/Receiver (12-bit 3.0 GSPS DAC and 12-bit 3.2 GSPS ADC)

On-board PLL/oscillator or from external reference clock (up to 2 GHz)

Reliability Balanced design assurance plan for Class A-D Missions

Fault-tolerant Microsemi CPLD to configure FPGA and low-level board monitor/control All components selected for high latch up immunity and total dose, up to 100 krad

Radiation-hardened POL voltage-converters for on-board power generation

Additional Features

Ruggedization High-Shock, High-Vibration, Up to QML Class

Serial RapidIO, SpaceWire, LVDS, LVTTL and single-ended 50 ohm RF

131,072 CLBs, 10,728 Kb Max Block RAM, 320 DSP Slices

Up to two (2) simultaneous FPGA bit files in MRAM (compression required) Custom FW and custom mezzanine designs available from reference designs

Contact Us: SES-BD@tridsys.com



Reprogrammability

Customization

Interfaces

FPGA